

**Vishay Siliconix** 

RoHS

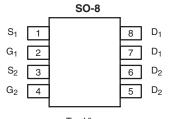
COMPLIANT

HALOGEN

**FREE** Available

#### Dual P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a, e</sup>	Q <sub>g</sub> (Typ.)			
- 20	0.0192 at V <sub>GS</sub> = - 10 V	- 8	20			
	0.0330 at $V_{GS}$ = - 4.5 V	- 8	20			



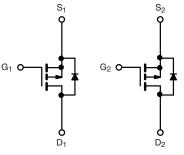
Top View

Ordering Information: Si4943CDY-T1-E3 (Lead (Pb)-free) Si4943CDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

- Halogen-free According to IEC 61249-2-21
   Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>q</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Load Switching
  - Computer
  - Game Systems
- Battery Switching
- 2-Cell Li-Ion



P-Channel MOSFET P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 20	v		
Gate-Source Voltage	V <sub>GS</sub>	± 20			
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ $T_{A} = 25 \text{ °C}$ $T_{A} = 70 \text{ °C}$	I <sub>D</sub>	- 8 <sup>e</sup> - 8 <sup>e</sup> - 8 <sup>b, c, e</sup> - 6.7 <sup>b, c</sup>	_	
Pulsed Drain Current (10 µs Pulse Width)	I <sub>DM</sub>	- 30	A		
Source-Drain Current Diode Current	T <sub>C</sub> = 25 °C T <sub>A</sub> = 25 °C	۱ <sub>S</sub>	- 2.5 - 1.7 <sup>b, c</sup>		
Pulsed Sorce-Drain Current	I <sub>SM</sub>	- 30			
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 11		
Single-Pulse Avalanche Energy	L = 0.1 IIIA	E <sub>AS</sub>	6	mJ	
Maximum Power Dissipation	$T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ $T_{A} = 25 \text{ °C}$ $T_{A} = 70 \text{ °C}$	P <sub>D</sub>	3.1 2 2 <sup>b, c</sup> 1.28 <sup>b, c</sup>	w	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 50 to 150	°C		

THERMAL RESISTANCE RATINGS						
		Lir				
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	50	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	30	40	C/ W	

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

e. Package Limited.

c. t = 10 s.

d. Maximum under Steady State conditions is 110  $^{\circ}\text{C/W}.$ 





Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static			•	•		•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 21		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			5.4		mv/ C	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			- 100	nA	
Zero Gate Voltage Drain Current	lass	$V_{DS} = -20 V, V_{GS} = 0 V$	- 1		- 1		
Zero Gale vollage Dialit Current	IDSS	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = -10 V$	- 30			Α	
	Baar	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 8.3 A		0.0160	0.0192	Ω	
Drain-Source On-State Resistance <sup>D</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 6.4 A		0.0275	0.0330		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 8.3 A		19		S	
Dynamic <sup>a</sup>			•	•		•	
Input Capacitance	C <sub>iss</sub>			1945		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		460			
Reverse Transfer Capacitance	C <sub>rss</sub>			385			
Total Gate Charge	Qg	$V_{DS}$ = - 10 V, $V_{GS}$ = - 10 V, $I_{D}$ = - 8.3 A	41	62			
				20	30	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -8.3 \text{ A}$		7			
Gate-Drain Charge	Q <sub>gd</sub>			9			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.5	2.5	5	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			13	20		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 1.5 $\Omega$		11	17		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 6.7 A, $\text{V}_\text{GEN}$ = - 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		35	53		
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			50	75	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 1.5 $\Omega$		71	107		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 6.7 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		29	44		
Fall Time	t <sub>f</sub>	1 1		15	23		
Drain-Source Body Diode Characteris	tics						
Continuous Source-Drain Diode Current	١ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 2.5	А	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 30		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 6.7 A		- 0.77	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			30	45	ns	
Body Diode Reverse Recovery Charge	Diada Bayarsa Basayary Chargo			17	26	nC	
Reverse Recovery Fall Time	ta	I <sub>F</sub> = - 6.7 A, dI/dt = 100 A/μs, T <sub>J</sub> = 25 °C		13		ns	
-	-						

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

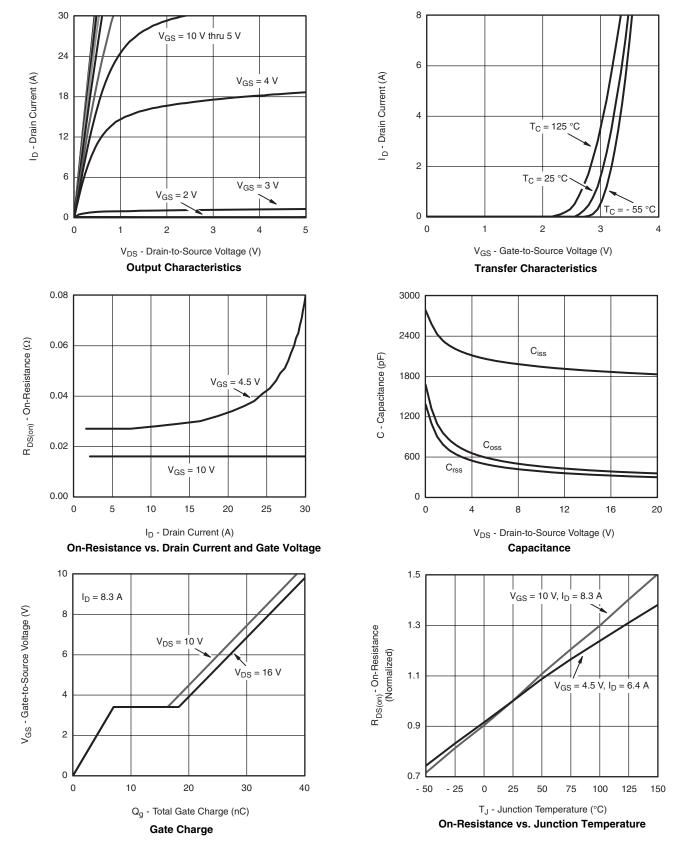
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





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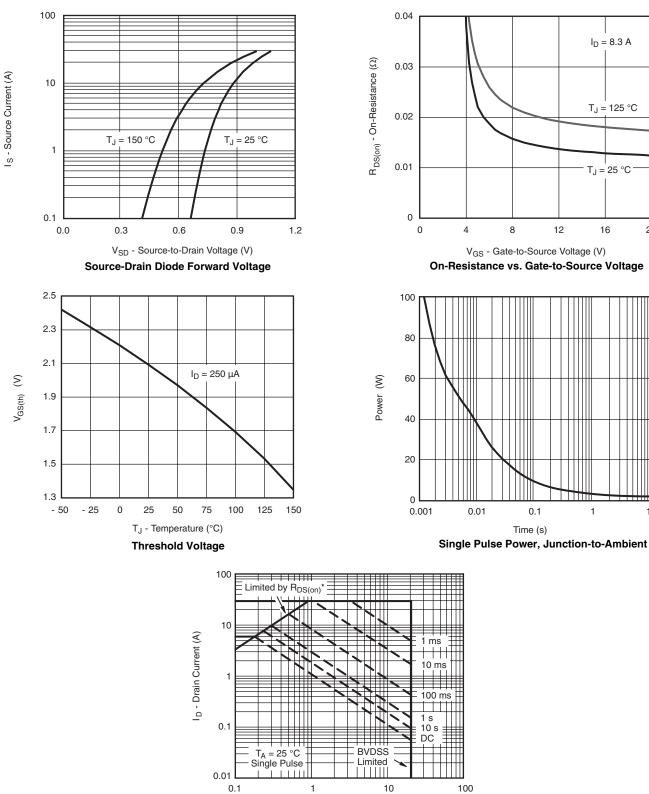


20

10

#### Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



V<sub>DS</sub> - Drain-to-Source Voltage (V)

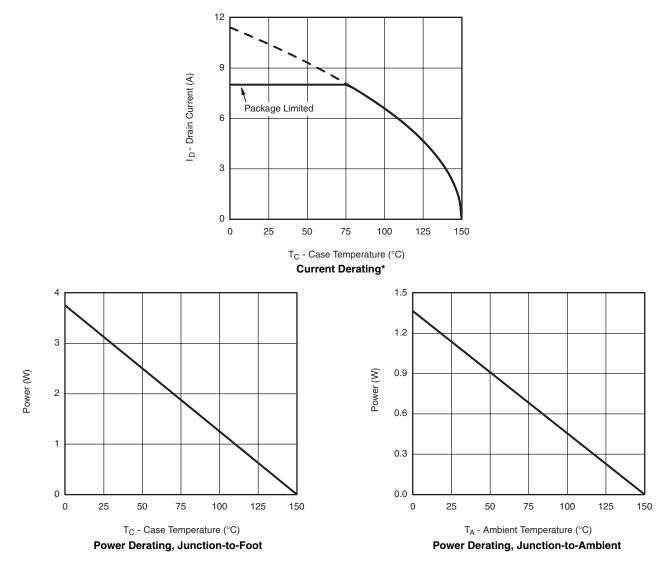
**New Product** 

VISHAY.

# Si4943CDY

Vishay Siliconix



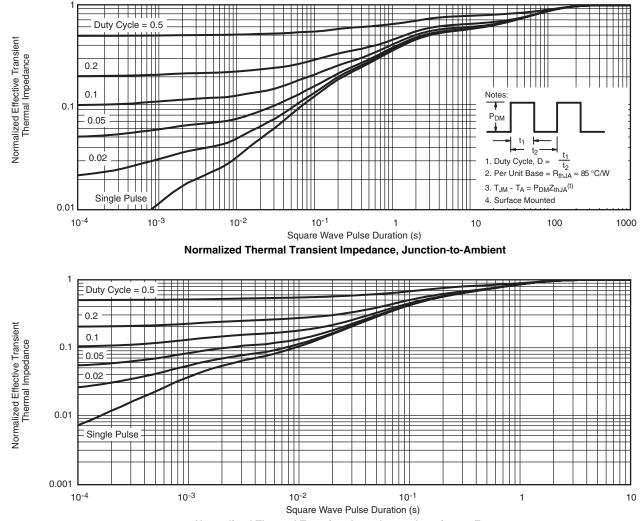


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### **Vishay Siliconix**

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?69985">www.vishay.com/ppg?69985</a>.



# Package Information

Vishay Siliconix

#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





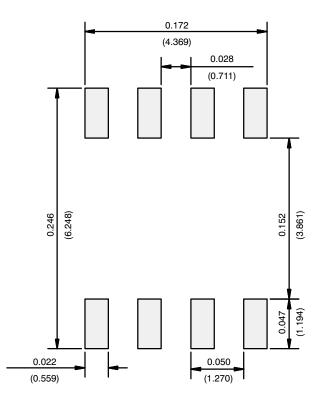
	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

## **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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